

BF246B N-Channel Switch

• This device is designed for low level analog switching, sample and hold circuits and chopper stabalized amplifiers.

• Sourced from process 51.

• See J111 for characteristics.



Absolute Maximum Ratings* T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{DG}	Drain-Gate Voltage	25	V
V _{GS}	Gate-Source Voltage	-25	V
I _{GF}	Forward Gate Current	50	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 ~ 150	°C

* These ratings are limiting values above which the serviceability of any semiconductor device may e impaired.

Notes:

1. These ratings are based on a maximum junction temperature of 150 degrees C.

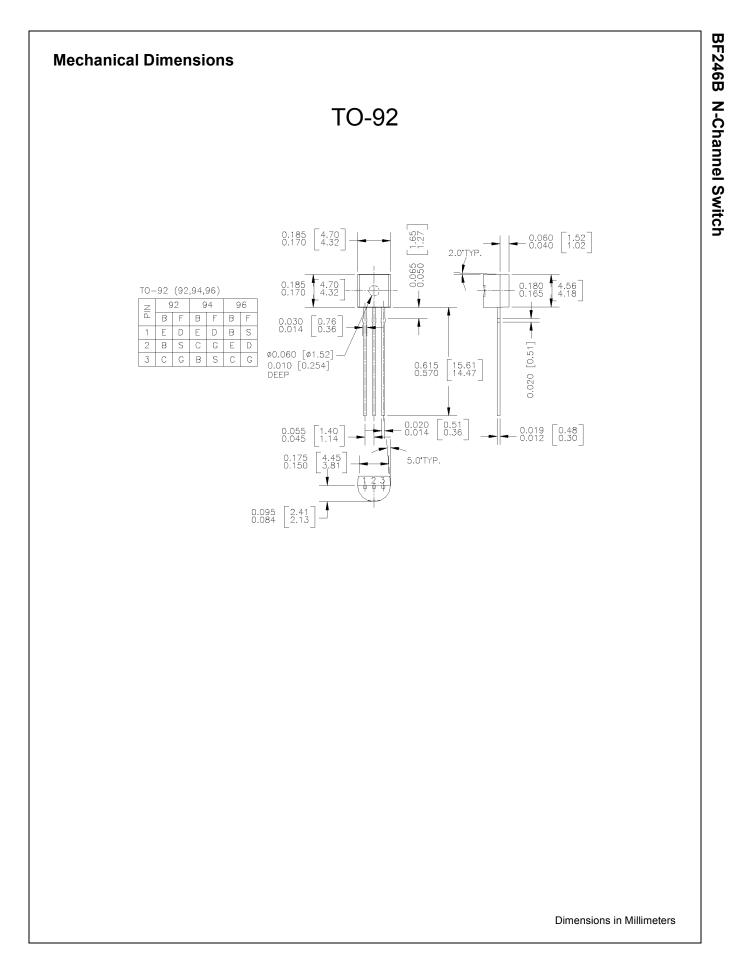
2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max	Units		
Off Characteristics							
V _{(BR)GSS}	Gate-Source Breakdown Voltage	$I_{G} = 1.0 \mu A, V_{DS} = 0$	-25		V		
I _{GSS}	Gate Reverse Current	V _{GS} = -15V, V _{DS} = 0		-5.0	nA		
V _{GS(off)}	Gate-Source Cutoff Voltage	V _{DS} = 15V, I _D = 10nA	-0.6	-14.5	V		
On Charact	teristics*						
I _{DSS}	Zero-Gate Voltage Drain Current *	V _{DS} = 15V, V _{GS} = 0	60	140	mA		

Thermal Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
P _D	Total Device Dissipation	625 5.0	mW mW/°C
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	125	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	357	°C/W



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